

Halogens free devices

CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 30 Volts CURRENT 2.8 Ampere

CHM7400SGP

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

- * Small flat package. (SC-88)
- * Super high dense cell design for extremely low R_{DS(ON)}.
- * High power and current handing capability.
- * Lead free product is acquired.

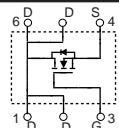
CONSTRUCTION

- * N-Channel Enhancement

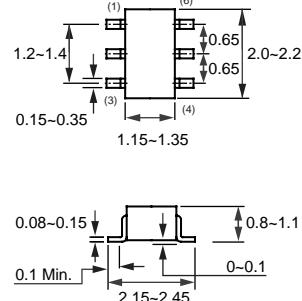
MARKING

- * 7400

CIRCUIT



SC-88/SOT-363



Dimensions in millimeters

SC-88/SOT-363

Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Symbol	Parameter	CHM7400SGP	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Maximum Drain Current - Continuous	2.8	A
	- Pulsed	10	
P _D	Maximum Power Dissipation	625	mW
T _J	Operating Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1)	250	°C/W
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2007-10

RATING CHARACTERISTIC CURVES (CHM7400SGP)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
I_{GSSF}	Gate-Body Leakage	$V_{\text{GS}} = 12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{\text{GS}} = -12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

ON CHARACTERISTICS

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	0.8		1.6	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10 \text{ V}, I_D=2.8 \text{ A}$ $V_{\text{GS}}=4.5 \text{ V}, I_D=2.3 \text{ A}$		62	77	$\text{m}\Omega$

SWITCHING CHARACTERISTICS

Q_g	Total Gate Charge	$V_{\text{DS}}=15 \text{ V}, I_D=2.0 \text{ A}$ $V_{\text{GS}}=4.5 \text{ V}$		4.2	6	nC
Q_{gs}	Gate-Source Charge			0.6		
Q_{gd}	Gate-Drain Charge			1.5		
t_{on}	Turn-On Time	$V_{\text{DD}}=15 \text{ V}$ $V_{\text{GS}}=10 \text{ V}$ $R_{\text{GEN}}=10 \Omega, R_L=10 \Omega$		2.5		nS
t_r	Rise Time			2.5		
t_{off}	Turn-Off Time			20		
t_f	Fall Time			4		

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_s	Drain-Source Diode Forward Current			2.5	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_s = 1.25 \text{ A}, V_{\text{GS}} = 0 \text{ V}$		1.2	V